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Gel-tape-casting of aluminum nitride ceramics

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Abstract: Aluminum nitride ceramic sheets were formed for the first time by a novel and simple method, namely gel-tape-casting process, where only two additives were used to prepare the slurries. PIBM (a water-soluble copolymer of isobutylene and maleic anhydride) acted as both dispersant and gelling agent, and PEG (polyethylene glycol) acted as plasticizer. Combining the advantages of gel-casting and tape-casting processes, flexible and uniform green tapes were obtained. The rheological properties of AlN slurries were studied to optimize the PIBM content and solids loading. After drying and debinding, the green sheets were sintered at 1840 °C in N₂ atmosphere. Homogeneous microstructure with average grain size of about 7 μ m was observed in the final AlN ceramics. Thermal conductivity of the AlN ceramics was 161 W/(m·K).

Keywords: AlN ceramic sheets; gel-tape-casting; PIBM; rheological properties; microstructure

1 Introduction

With high thermal conductivity [1], high electrical resistance, and low dielectric property, aluminum nitride has been considered as the most promising material for substrates, especially for high power circuitry in microelectronics field. Generally, high quality thin AlN ceramic substrates for electronic applications are fabricated by tape-casting process [2]. There are two types of tape-casting process based on different kinds of solvents, non-aqueous and aqueous systems [3,4]. For the non-aqueous system, organic additives are flammable and toxic, which would cause environmental problems. As more and more attention is paid on environment protection, researchers are trying

to find ways to replace those organics. As a result, the aqueous system was developed, which is incombustible, non-toxic, and environmentally friendly.

Up to now, reports on aqueous tape-casting of AlN were rare. As hydrolysis would occur when AlN powder was dispersed in water, surface modification was needed for AlN powder. In 2004, Luo *et al.* [5] used DP270 as both dispersant and hydrolysis inhibitor to prepare AlN green sheets by aqueous tape-casting. In 2005, Olhero and Ferreira [6] prepared water-based AlN slurries by adding H_3PO_4 as a protective agent against hydrolysis. Binders and dispersants are also needed in aqueous tape-casting, and the addition contents are always very high, which would also cause environmental problems in the debinding process.

On the other hand, due to the migration of the solvents, inhomogeneous microstructure would form along the thickness of the tape, which makes it impossible to prepare thick sheets. Thus, a complicated

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method combining stack and WIP (warm isostatic pressing) was used to make thick sheets. Gel-casting is a near-net shaping method for ceramic forming with complex shapes [7], which is suitable for preparing bulk ceramics without forming inhomogeneous microstructure. In 2002, Xiang et al. [8] developed a novel method called gel-tape-casting to produce alumina sheets. It combined tape-casting with gel-casting technology which is based on free radical polymerization. However, five kinds of additives were used: dispersant, monomer, cross-linking agent, catalyst, and initiator. In addition, plasticizer was added to improve the flexibility of green tapes. Except for the multiple additives, there was an anti-polymerizing effect of oxygen, which made the process complicated. In 2004, a novel gel-tape-casting process using sodium alginate was reported [9]. Sodium alginate was dissolved in water at room temperature and formed a three-dimensional network in the presence of multivalent cations. Styrene-acrylic latex was used to improve the flexibility of green tapes. Gelation rate could be controlled by the amounts of adipic acid and sequestrant. Green tapes with homogeneous microstructure were fabricated by this process. In 2014, a new system in shaping techniques by in situ polymerization was reported. Instead of commonly applied 2-hydroxyethyl acrylate or acrylamide (monomer) and N,N,N',N'-tetramethylethylenedia mine (activator), 3-O-acryloyl-D-glucose and Lascorbic acid were used as monomer and activator, respectively [10]. The new system based on non-toxic glucose derivatives has been described in detail, and it allowed to form defect free tapes and dense sintered bodies by gel-tape-casting.

In 2013, Yang *et al.* [11] developed a simple method for gel-casting of alumina ceramics using a non-toxic and water-soluble copolymer of isobutylene and maleic anhydride (simply noted as PIBM). It only needed small amount of PIBM (0.3 wt%) which acted as both dispersant and gelling agent for gel-casting of ceramics. Also, oxygen inhibition would not occur in this system. Then in 2014, Shu *et al.* [12] fabricated AlN ceramics with a fin-like shape by gel-casting process with addition of PIBM. These studies show that PIBM would be a better choice for preparing slurries, which make it easier for fabricating complicated and large-size ceramics.

In this study, tape-casting and the simple novel gel-casting process using PIBM were combined to obtain flexible and uniform aluminum nitride ceramic green tapes. Only small amounts of additives were added. Finally, dense AlN ceramic sheets were fabricated by pressureless sintering at 1840 $^{\circ}$ C for 4 h in N₂ atmosphere.

2 Experimental procedure

Commercial AlN powder (Grand F, Tokuyama Co., Japan) with an average particle size of 1.1 µm was used as raw material, and the density was 3.26 g/cm^3 . Y_2O_3 was used as sintering aid [13], and its average particle size and density was $2.0 \,\mu\text{m}$ and $5.01 \,\text{g/cm}^3$, respectively. Because of the hydrolysis of these two kinds of powder [14], they were coated with a waterproof agent. The waterproof agent is a commercial waterproof material, whose main component is polyurethane. AlN, Y₂O₃, and the waterproof agent were mixed in alcohol for 2 h, and then the mixed slurry was dried at 50 °C. PIBM with an average molecular weight of 160 000-170 000 (ISOBAM 110#, Kuraray, Osaka, Japan) was used as both dispersant and gelling agent [11], and its molecular structure is shown in Fig. 1. Polyethylene glycol (PEG600) was used as plasticizer.

The experimental process of gel-tape-casting is shown in Fig. 2. First, PIBM solution was prepared, and the coated AlN and Y_2O_3 (3 wt% with respect to AlN)



Fig. 1 Molecular structure of PIBM.



Fig. 2 Flowchart of the gel-tape-casting process.

powder and PEG600 (5 wt% with respect to AlN) were added into the solution to make the slurry. Then, ball milling was used (200 rpm, 4 h) to make the slurry well-distributed. The slurry was degassed (1000 rpm, 0.05 atm, 30 s) by THINKY MIXER ARV0-310. Then, the slurry was poured into the reservoir and tape-casted in air with a doctor blade of 20 cm in width to get the green tapes. After demolding and debinding, the green sheets were sintered at 1840 $^{\circ}$ C for 4 h in N₂ atmosphere.

Rheological behavior was characterized with a stress-controlled rheometer (Physica MCR301, Anton Paar, Graz, Austria) with a parallel plate (25 mm in diameter). The viscosities of the slurries were measured with the continuous shear mode increasing from 1 to 1000 s^{-1} at 25 °C. Microstructure and energy dispersive spectrum (EDS) test were carried out by scanning electron microscopy (SEM, JSM-6390, JEOL, Japan) and field emission scanning electron microscopy (FESEM, GeminiSEM 500, Zeiss, Germany). Thermal diffusivity was measured by laser-flash method. The density of AlN ceramics was measured by the Archimedes method in distilled water.

3 Results and discussion

3.1 Rheological properties of AlN slurries

High solids loading, good fluidity, and stability are expected for both tape-casting and gel-casting, so they are also important in the slurries for gel-tape-casting. For typical slurries, the rheological behavior is influenced by ceramic powder, solvent, solids loading, dispersant, binder, and other organic additives, and the content of binder is the most important factor [3]. PIBM is a copolymer of isobutylene and maleic anhydride, so it can act as dispersant as well as binder in slurries. Rheological behaviors of the slurries with different binder content and solids loading were investigated.

3. 1. 1 Viscosity of AlN slurries varying with binder addition

Rheological properties of the slurries with different PIBM concentration are shown in Fig. 3. The solids loading of the slurries was fixed to 38 vol% and the PIBM addition was in the range of 2–4 wt% (powder-based) at room temperature. The slurry compositions are listed in Table 1. It is clear that all slurries show a shear-thinning character with increasing



Fig. 3 Viscosity of AlN slurries with different PIBM content (solids loading: 38 vol%).

Table 1Composition of AlN slurries with differentPIBM addition and solids loading

No.	Solids loading (vol%)	PIBM (wt% of AlN powder)
1	38	2
2	38	3
3	38	4
4	40	3
5	42	3

shear rate. In addition, the viscosity increases with increasing PIBM content from 2 to 4 wt%. When the addition content of PIBM increases from 3 to 4 wt%, there is little change in the viscosity of the slurries. While, for lower content (2 wt%), the strength of green tape is poor and it is difficult to get an intact green tape off the carrier. Therefore, 3 wt% PIBM content was chosen for the gel-tape-casting and demolding process.

3. 1. 2 Viscosity of AlN slurries varying with solids loading

Figure 4 shows the viscosity of slurries as a function of solids loading and 3 wt% PIBM. The compositions of the slurries are listed in Table 1, and the solids loading is varied from 38 to 42 vol%. It could be found that all the slurries show a shear-thinning behavior. The two curves of slurries with solids loading of 38 and 40 vol% are very close. And the viscosity increases significantly when the solids loading increases up to 42 vol%. It is important to obtain stable and homogeneous slurry with low viscosity and high solids loading, whereas higher solids loading can result in high viscosity and inhomogeneous slurry. As we can see, the slurry with a solids loading of 40 vol% has proper viscosity and relatively high solids loading. From Fig. 3 and Fig. 4, the slurry with 40 vol% solids loading and 3 wt% PIBM has the best performance, so they are the optimal conditions for the gel-tape-casting process.



Fig. 4 Viscosity of AlN slurries with different solids loading (PIBM addition: 3 wt%).

3. 2 Effect of plasticizer on storage modulus

In traditional gel-casting system, there is no plasticizer. Thus, after casting and drying, the green body is hard and brittle. In the gel-tape-casting process, in order to obtain flexible green tape, plasticizer was used. The storage modulus is often used for the characterization of gelation rate. As shown in Fig. 5, without the plasticizer, the slurry shows a high storage modulus behavior with time going, which is similar to the normal gel-casting process. After the addition of plasticizer, the curve shows a similar tendency, but the value of storage modulus is much smaller. In other words, the plasticizer greatly prolongs the curing time, and after drying, the green body is flexible instead of hard and brittle.

3.3 Characterization of AIN green tapes

With the addition of appropriate amount of plasticizer, flexible tapes were obtained and shown in Fig. 6(a), and the thickness of the tapes was between 250 and 550 μ m. The green tapes produced from slurry with solids loading of 40 vol% and binder addition of 3 wt% were



Fig. 5 Effect of plasticizer on the evolution of storage modulus G' of slurries with a solids loading of 40 vol%.



Fig. 6 (a) Photograph and (b) microstructure of AlN green tape after casting in air at room temperature.

smooth, uniform, and without cracks. The microstructure of the green tapes is shown in Fig. 6(b). It can be seen that the AlN particles are homogeneously distributed and there are no obvious defects. All the organic additives were burned out by the debinding process, with temperature up to 500 $^{\circ}$ C.

3.4 Properties of dense AIN ceramics

Dense AlN ceramics were obtained by pressureless sintering at 1840 °C for 4 h in N_2 , as shown in Fig. 7. The average grain size is about 7 µm, and no visible pores or defects are observed. However, second phases can be clearly seen on the grain boundaries. EDS test was carried out to determine the composition of the second phases. Figure 8 shows the EDS mapping results of the fracture surface of the ceramics. Obviously, Y and O elements are distributed on the grain boundaries. As the sintering temperature is high, Y₂O₃ and AlN can react with each other, so compounds with Y, Al, O, and Y₂O₃ can be the second phases. Spot scanning of the second phases also shows that Al, Y, and O elements are distributed. The composition of the second phases and their distribution would affect the thermal conductivity of AlN ceramics [15].

The density of the AlN ceramics was determined by the Archimedes method, which is 3.3 g/cm^3 . Thermal diffusivity was measured by the laser-flash method. The



Fig. 7 Microstructure of the dense AlN ceramic fracture (backscattered electron image).



Fig. 8 EDS mapping of the AlN ceramics on fracture surface.

thermal conductivity of the ceramics is determined from the following formula:

$$\lambda = \alpha \cdot \rho \cdot C_p \tag{1}$$

where α is the thermal diffusivity (cm²/s), ρ is the density (g/cm³), and C_p is the heat capacity of the material (J/(g·K)). The tested thermal diffusivity is 0.66284 cm²/s. The heat capacity of pure, dense AlN (0.734 J/(g·K) at 20 °C) was used to calculate thermal conductivity of the AlN ceramics and it is 161 W/(m·K). It is lower than the reported one (204 W/(m·K) in Ref. [12]). As we know, the thermal conductivity of AlN

ceramics is affected by the low thermal conductive second phases segregated in grain boundary, including the morphology and microstructure of the second phases [16]. From the microstructure and EDS analysis (Figs. 7 and 8), the second phases are connected to each other, which would decrease the thermal conductivity of the AlN sheet to a large extent. By changing the morphology of the second phases into isolated structures, it can improve the thermal conductivity. On the other hand, as the distribution of the second phases is not uniform in the ceramics, it can be inferred that the waterproof agent does not play an effective role. This would lead to inhomogeneous hydrolysis of AlN and Y_2O_3 in the slurries and increase the generation of second phases. Further study will be carried out to solve these problems and improve the thermal conductivity of the AlN ceramic sheet.

4 Conclusions

A simple gel-tape-casting method was used to prepare AlN ceramic sheets. A copolymer PIBM was employed as both dispersant and gelling agent, and PEG was used as plasticizer. With the addition of 3 wt% PIBM and a solids loading of 40 vol%, the aqueous slurries showed the best performance and flexible green tapes were obtained. After the debinding and pressureless sintering, dense AlN sheets with an average grain size of about 7 µm and no big pores or other defects were obtained. Thermal conductivity of the prepared AlN sheets reached 161 W/($m\cdot K$). The results showed that PIBM is an effective and environmentally friendly additive for gel-tape-casting of AlN ceramic sheets, and the effective control of the composition and distribution of the second phases will improve the properties of the AlN sheets.

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